Stability of Fatigued Dislocation Wall Structure in Coarse-Grained and Ultrafine-Grained Aluminum against Monotonic Tensile Deformation

Yukito Nakanishi1,1, Yoji Miyajima1, Toshiyuki Fujii2, Susumu Onaka1 and Masaharu Kato1

1Department of Materials Science and Engineering, Tokyo Institute of Technology, Yokohama 226-8502, Japan
2Department of Innovative and Engineered Materials, Tokyo Institute of Technology, Yokohama 226-8502, Japan

Coarse-grained (CG) and ultrafine-grained (UFG) pure aluminum samples fabricated by equal channel angular pressing (ECAP) were cyclically deformed at 77 K under constant plastic strain amplitude. Monotonic tensile tests were performed at 300 and 77 K after the fatigue tests. In spite of the increase in the tensile strength of fatigued CG Al, tensile ductility decreased remarkably in comparison to that of as-annealed CG Al. On the other hand, the ultimate tensile strength (UTS) and tensile ductility of UFG Al were much higher at 77 K than those at 300 K. Furthermore, UFG Al at 77 K maintained high UTS and high tensile ductility even after fatigue tests. Microstructural observation has revealed that dislocation wall structure formed in fatigued CG Al persists after the monotonic tensile tests. However, dislocation wall structure formed in fatigued UFG Al disappeared during early stages of monotonic tensile tests at both 300 and 77 K. These results indicate that the dislocation wall structure in UFG Al is unstable against succeeding monotonic tensile deformation.

1. Introduction

Ultrafine-grained (UFG) metals have been produced by severe plastic deformation (SPD) such as equal channel angular pressing (ECAP),1 accumulative roll-bonding (ARB)2 and high-pressure torsion (HPT).3 UFG fcc metals are known to show some characteristic physical and mechanical properties that are different from those of coarse-grained (CG) fcc metals, such as easier recrystallization and recovery,4–6 higher temperature and strain-rate dependencies of strength7,8 and deviation from the Hall–Petch relationship.9,10 In order to reveal the mechanism of such characteristic properties, many researchers have proposed various deformation models of UFG materials.11–27

Fatigue behavior of UFG metals is also unique and different from that of single-crystalline and CG metals. For high-cycle stress-controlled tests where strength is a major factor in determining the fatigue life, UFG metals show superior fatigue life compared with single-crystalline and CG metals.28–31 On the other hand, UFG metals show deteriorated fatigue life for low-cycle strain-controlled fatigue tests where fatigue life is mainly controlled by ductility.28–31 For the low-cycle tests, it is also known that UFG pure aluminum shows hardening followed by softening28,29 and distinct fatigue dislocation structure has not been observed in grains at room temperature.29 In contrast, single-crystalline and CG Al show initial hardening, softening and secondary hardening32–34 with the formation of characteristic dislocation structure such as vein35,36 wall,35,36 labyrinth32,35,37 and cell32,34 structures.

Although the cyclic deformation behavior of UFG Al is worth investigating more in detail, most reports were on commercially pure Al or on Al alloys. We have recently reported that test temperature plays an important role on the fatigue behavior of high purity UFG Al and very fine dislocation wall structure is formed when tested at 83 K in grains smaller than a few micrometers.38,39

In this study, low-cycle fatigue tests were carried out under strain-control at 77 K using CG and UFG Al, and monotonic tensile tests were performed in succession either at 300 or 77 K after the fatigue tests. From the results of monotonic tensile tests and transmission electron microscopy (TEM), the formation and stability of the fatigued dislocation structure are studied.

2. Experimental Procedure

High-purity Al (99.98 mass%) was used for the present study. Al sheets were annealed at 673 K for 2 h to obtain a fully recrystallized material. Average grain size of the as-annealed Al was about 300 µm and this material will be referred to as as-annealed CG Al.

CG Al samples cut into a rod shape of 10 mm in diameter and 60 mm in length were prepared for the ECAP deformation at 300 K. Each rod was subjected to 8 passes of ECAP under route Bc (rotation by 90° in each pass).1 After the ECAP deformation, average grain size of UFG Al became about 1.3 µm and this material will be referred to as-ECAPed UFG Al. According to Salem et al.,40 grain refinement in pure Al is strongly dependent on the purity of the material. In fact, Kawasaki et al. has reported that the grain size of 99.99 mass% Al can be at the smallest 1.2 µm by the ECAP technique.31 Therefore, the obtained average grain size of 1.3 µm in the present study is reasonably larger than that of commercially pure Al fabricated by the same ECAP condition.28,29 Nevertheless, we have chosen high purity Al for the purpose of avoiding the effects of impurities and investigating the primary mechanical and physical properties of Al.

The fatigue specimens with the gauge length of 10 mm and cross-sectional area of 5 × 6 mm2 were taken from the central part of the as-ECAPed rods by spark erosion in the direction...
parallel to the rod axis. The specimens were mechanically polished with silicon-carbide paper and electrolytically polished using solution of 20% perchloric acid and 80% methanol.

Fully reversed tension-compression low-cycle fatigue tests were carried out at 77 K for these CG (as-annealed) and UFG (as-ECAPed) Al specimens under a constant plastic strain amplitude of either $\varepsilon_{pl} = 1 \times 10^{-3}$ or $5 \times 10^{-3}$ using an electro-hydraulic testing machine (Shimadzu Servopet). The specimens were immersed in liquid nitrogen to achieve the low temperature atmosphere during the fatigue tests. Strain was measured with an extensometer mounted directly on the gauge section and constant strain rate of $4 \times 10^{-3} \text{s}^{-1}$ was employed using a triangular command signal. After reaching the saturation of stress amplitude, fatigue tests were stopped at the cumulative plastic strain $\varepsilon_{cum}$ of 10 (for UFG Al) and 50 (for CG Al). Here, the cumulative plastic strain is defined as

$$\varepsilon_{cum} = 4N\varepsilon_{pl}$$

where $N$ is the number of fatigue cycles. Since UFG Al generally shows shorter fatigue life than CG Al at low-cycle fatigue tests,\textsuperscript{28,29,31} it is reasonable that UFG Al reached stress saturation at smaller cumulative plastic strain than CG Al. No cracks were observed on the surface of specimens after the fatigue tests mentioned above.

The tensile specimens with a gauge length of 10 mm and cross-sectional area of $1 \times 3 \text{mm}^2$ were sliced from the fatigue specimens and polished under the same conditions as those used to prepare fatigue specimens. Monotonic tensile tests were carried out at 300 and 77 K for un-fatigued (as-annealed and as-ECAPed) and fatigued specimens at a constant strain rate of $4 \times 10^{-3} \text{s}^{-1}$ using an Instron-type testing machine (Minebea TG-50kN).

The fatigued and monotonically deformed specimens were sliced into 3 mm diameter disks and ground down to a thickness of 0.2 mm with silicon-carbide paper. Then, the samples were electrolytically polished on a twin-jet polisher (Struers Tenupol-5) in solution of 8% perchloric acid, 10% 2-butoxyethanol and 82% methanol. TEM observations were performed by using a JEOL 2011 microscope with an acceleration voltage of 200 kV.

During the course of this study, we found that when fatigued specimens at 77 K were stored at room temperature, dislocation structure formed by the fatigue test disappeared in a few months for CG Al and in a few weeks for UFG Al. To avoid such possibility of natural annealing and to ensure the preservation of dislocation structure until TEM observation, fatigued and deformed specimens were always stored in liquid nitrogen.

More concretely, specimens were handled very carefully so that they were exposed at room temperature for less than 1 h between the fatigue and tensile tests and between the tensile tests and the TEM observation.

3. Results

3.1 Fatigue behavior of CG and UFG Al

Figure 1 shows cyclic hardening curves of CG (as-annealed) and UFG (as-ECAPed) Al fatigued at 77 K. CG Al shows rapid hardening to saturation. At this test temperature, CG Al does not show either softening or secondary hardening characteristic of the room-temperature fatigue behavior of single-crystalline and CG Al.\textsuperscript{31-33} The saturation stress of CG Al in this study was 118 MPa ($\varepsilon_{pl} = 1 \times 10^{-3}$) and 126 MPa ($\varepsilon_{pl} = 5 \times 10^{-3}$).

The fatigue behavior of UFG Al at 77 K is similar to that of CG Al at 77 K. UFG Al shows slight hardening followed by stress saturation. The saturation stress of UFG Al in this study was 151 MPa ($\varepsilon_{pl} = 1 \times 10^{-3}$) and 186 MPa ($\varepsilon_{pl} = 5 \times 10^{-3}$). Since UFG Al has experienced extensive work hardening during the ECAP deformation, it is natural that cyclic hardening rate of UFG Al is lower compare to that of CG Al.

3.2 Monotonic tensile deformation behavior of fatigued Al

The tensile stress–strain curves at 300 and 77 K of as-annealed and fatigued CG Al are shown in Fig. 2. For both as-annealed and fatigued CG Al, the ultimate tensile strength (UTS) and tensile ductility are larger at 77 K than at 300 K. When test temperature is the same, fatigued CG Al shows much higher yield strength and much lower tensile ductility than as-annealed CG Al.

Fig. 1 Cyclic hardening curves of CG and UFG Al fatigued under constant plastic strain amplitudes $\varepsilon_{pl} = 1 \times 10^{-3}$ and $5 \times 10^{-3}$ at 77 K.

Fig. 2 Stress–strain curves at 300 and 77 K of as-annealed and fatigued CG Al.
The monotonic tensile deformation behavior of UFG Al was quite different from that of CG Al. Figure 3 shows the tensile stress–strain curves of as-ECAPed and fatigued UFG Al monotonically deformed at 300 and 77 K. There are at least two remarkable points to be noted in Fig. 3. First, regardless of as-ECAPed or fatigued UFG Al, UTS and tensile ductility at 77 K are much higher than those at 300 K. Secondly, UFG Al at 77 K maintains high UTS and high tensile ductility even after the fatigue tests. These findings will be discussed later.

3.3 Microstructural observation

TEM images taken from fatigued and deformed specimens of CG Al are shown in Figs. 4(a) to 4(c). After the fatigue tests of CG Al, fine dislocation walls were found to be developed in all grains (Fig. 4(a)). These dislocation walls were nearly parallel to (100). It appears that two mutually perpendicular sets of walls exist in Fig. 4(c). These walls are considered to form layers, just like the labyrinth walls. The average channel width between adjacent walls was about 350 nm ($\varepsilon_{pl} = 1 \times 10^{-3}$) and about 330 nm ($\varepsilon_{pl} = 5 \times 10^{-3}$). The absence of contrast variation among the channels indicates that the walls are made of edge dislocation dipoles. As will be discussed later, the observed channel widths in this study are much narrower than the frequently observed widths between 1 to 4 µm in single-crystalline and CG Al fatigued at room-temperature.

What should also be noted in Fig. 4 is that dislocation walls formed during fatigue in CG Al persists even after monotonic tensile tests at 300 and 77 K and no distinct change in the dislocation wall structure was noted before and after the monotonic tensile tests (Figs. 4(b) and 4(c)).

Figures 5(a) to 5(d) show TEM images taken from fatigued and deformed specimens of UFG Al. Similar to CG Al, dislocation walls nearly parallel to (100) are formed in many grains of UFG Al and the average channel width was about 320 nm ($\varepsilon_{pl} = 1 \times 10^{-3}$) and about 300 nm ($\varepsilon_{pl} = 5 \times 10^{-3}$). From the observation such as that in Fig. 5(b), we find that the fraction of grains that contain dislocation wall structure is nearly 40%. Considering the TEM visibility condition of dislocations, actual fraction may be larger. As is well known, dislocation multiplication and rearrangement are necessary to form certain fatigue dislocation structure including the present wall structure. If grain size is smaller, such dislocation activities would become more difficult due to smaller space and stronger constraint by the surrounding grain boundaries. Therefore, it is natural that the larger the grain size, the easier the formation of dislocation wall structure.

It is very interesting to find from Fig. 5 that dislocation wall structure formed during fatigue tests at 77 K disappears after succeeding monotonic tensile deformation (Figs. 5(c) and 5(d)). As described earlier, dislocation wall structure in CG Al persists even after monotonic tensile deformation at both test temperatures (Figs. 4(a) to 4(c)). Therefore, this disappearance of the wall structure is characteristic of UFG Al suggesting that the dislocation wall structure formed during fatigue tests in UFG Al is unstable against succeeding monotonic tensile deformation.
4. Discussion

4.1 The relationship between the channel width and stress amplitude

As mentioned earlier, the average channel width of CG and UFG Al fatigued at 77 K are much smaller than that of single-crystalline and CG Al fatigued at 300 K. Basinski et al. have reported that there is a linear relationship between shear stress amplitude $\tau_a$ and the reciprocal of channel width $1/d_c$, i.e.,

$$\tau_a = \frac{\alpha \mu b}{d_c}$$

(2)

where $\alpha$ is a dimensionless constant to be determined, $\mu$ the shear modulus and $b$ the magnitude of the Burgers vector. Though Brown and Mughrabi and Pschenitzka proposed more detailed relationships, we adopt eq. (2) not only for simplicity but also for different geometry: the $h_{100}$ walls observed in the present study are different from the usual $h_{110}$ walls of the so-called ladder structure in fcc metals.

Converting the shear stress amplitude into uniaxial stress amplitude $\sigma_a$ and using the Taylor factor $M = 3.06$, eq. (2) becomes

$$\sigma_a = \frac{\alpha M \mu b}{d_c}.$$  

(3)

With $\mu = 26.7$ GPa and $b = 0.286$ nm, calculated values of the constant $\alpha$ are shown in Table 1. According to theoretical studies by Brown and Pedersen the value of $\alpha$ is estimated to be 2.0. Therefore, the calculated values of $\alpha$ listed in Table 1 are close to the theoretical value.

![Fig. 5 TEM photographs of UFG Al: (a) fatigued at 77 K with $\epsilon_{pl} = 5 \times 10^{-3}$, zone axis of grain A: [001], (b) fatigued at 77 K with $\epsilon_{pl} = 5 \times 10^{-3}$ and then monotonically deformed till failure at 300 K, (d) fatigued at 77 K with $\epsilon_{pl} = 5 \times 10^{-3}$ and then monotonically deformed till failure at 77 K.](image)

Table 1 Experimental values of stress amplitude $\sigma_a$ and channel width $d_c$ and calculated values of constant $\alpha$ for CG Al and UFG Al.

<table>
<thead>
<tr>
<th>Stress amplitude: $\sigma_a$ [MPa]</th>
<th>Channel width: $d_c$ [nm]</th>
<th>Dimensionless constant: $\alpha$</th>
</tr>
</thead>
<tbody>
<tr>
<td>CG: $\epsilon_{pl} = 1 \times 10^{-3}$</td>
<td>118</td>
<td>350</td>
</tr>
<tr>
<td>CG: $\epsilon_{pl} = 5 \times 10^{-3}$</td>
<td>126</td>
<td>330</td>
</tr>
<tr>
<td>UFG: $\epsilon_{pl} = 1 \times 10^{-3}$</td>
<td>151</td>
<td>320</td>
</tr>
<tr>
<td>UFG: $\epsilon_{pl} = 5 \times 10^{-3}$</td>
<td>186</td>
<td>300</td>
</tr>
</tbody>
</table>

Figure 6 summarizes the experimental results of the inverse channel width under a given stress amplitude for single-crystalline Al, UFG Al in this study. From the slope of the straight line, we find $\alpha = 2.1$ which is again in good agreement with the theoretically-estimated value.

4.2 Relationship between monotonic tensile deformation behavior and microstructural stability of CG and UFG Al

The enhanced ductility of both CG and UFG Al at 77 K compared with that at 300 K (Figs. 2 and 3) has been known for many years. Some investigators have reported that both UTS and ductility of UFG Al become larger as temperature decreases.25-27,56 The larger UTS is a natural result of strong temperature dependence of strength in UFG materials.54-55 The larger ductility is mainly due to larger work hardening at 77 K than at 300 K. Since larger work hardening increases the stability of plastic deformation and, thus, delays the formation of necking in...
tensile specimens, it can be understood that both strength and ductility increases at 77 K than at 300 K regardless of the grain size.

In this study, we found that the effect of fatigue tests on succeeding monotonic tensile deformation behavior is quite different between CG and UFG Al. Let us first discuss the experimental results for CG Al. The fact that fatigued CG Al showed much higher yield strength and lower ductility than as-annealed CG Al (Fig. 2) can be understood reasonably since CG Al has experienced large cyclic hardening during the fatigue tests (Fig. 1). Dislocation wall structure is formed in all CG grains and it persists after monotonic tensile deformation (Figs. 4(b) and 4(c)). The persisting walls act as strong barriers against tensile deformation. Therefore, it is natural that fatigued CG Al shows much higher yield strength and lower tensile ductility than as-annealed CG Al.

The characteristic finding for the UFG Al is, on the other hand, that dislocation wall structure formed in UFG Al disappears completely during monotonic tensile deformation at both test temperatures (Figs. 5(c) and 5(d)). As mentioned previously, since all the specimens were store in liquid nitrogen in this study, the disappearance of the dislocation wall structure after monotonic tensile deformation is not due to the natural recovery. That is, monotonic tensile tests certainly accelerate the disappearance of dislocation wall structure.

We should note that fatigued UFG Al shows nearly the same UTS and tensile ductility as as-ECAPed Al at both temperatures. Therefore, the observed high UTS and ductility in as-ECAPed and fatigued UFG Al are believed to have something to do with the disappearance of the dislocation structure. Figures 7(a) and 7(b) show the microstructure of UFG Al fatigued at 77 K with εf = 1 × 10⁻³ and monotonically deformed at 77 K till a strain of 0.007 and 0.15, respectively. In Fig. 7(a), broken traces of dislocation wall structure can be seen. However, at the strain of 0.15 (Fig. 7(b)), neither dislocation wall structure nor its traces can be seen any more. These results indicate that dislocation wall structure in UFG Al disappears in the early stages of succeeding monotonic tensile deformation and acts at most as weak barriers against dislocation motion during monotonic tensile deformation.

Why is the dislocation structure formed in UFG Al less stable than that in CG Al? It is known that store energy introduced in materials increases with increasing the number of ECAP passes.6,57) For ECAPed Cu4,5) and HPTed Ni,6) recovery and recrystallization are known to take place more easily at lower temperatures than conventional recrystallization temperature of near 0.5 Tm (Tm: melting temperature). Recrystallization temperature decreases with increasing the stored energy.6) Moreover, Molodova et al.4) reported that the apparent activation energy Qr for recrystallization of ECAPed Cu decreases significantly with increasing the number of ECAP passes; Qr decreases from 1 eV at 1 pass to 0.7 eV at 8 passes. These reports indicate that higher stored energy causes UFG materials energetically unstable and results in the larger driving force for recovery and recrystallization. We believe that such low thermal stability of UFG materials4–6,57) explains, at least qualitatively, the easy disappearance of the dislocation wall structure.

Formation of dislocation wall structure is often related to the formation of persistent slip bands, surface intrusions and extrusions that are detrimental to fatigue resistance.48,58) However, since grain size is very small and since the unstable dislocation wall structure is formed only in selected grains of UFG Al, the dislocation walls do not appear to cause the extensive formation of persistent slip bands. From this viewpoint, the present unstable dislocation walls formed...
in UFG Al at 77 K may not be so harmful to the fatigue resistance. This is most probably the reason why ECAPed and fatigued UFG Al maintains nearly the same tensile strength and ductility as as-ECAPed UFG Al. Further studies are needed to discuss in more detail the relationship between the fatigue resistance and the degree of microstructural stability of UFG materials.

5. Conclusions

The low-cycle fatigue tests of high purity CG and UFG Al (99.98%) were carried out at 77 K. After the fatigue tests, CG and UFG Al were deformed in tension at 300 and 77 K. The results and findings are summarized as follows.

(1) During the strain-controlled fatigue tests, both CG and UFG Al show hardening to stress saturation at 77 K. The cyclic hardening rate of UFG Al is lower compare to that of CG Al.

(2) Fatigued CG Al shows much higher tensile strength and lower tensile ductility than as-anealed CG Al at 300 and 77 K. On the other hand, fatigued UFG Al shows almost the same tensile strength and ductility as as-ECAPed UFG Al at both 300 and 77 K.

(3) Fine dislocation wall structure is formed in all the CG grains during fatigue at 77 K. This dislocation wall structure in CG Al persists after monotonic tensile deformation at both 300 and 77 K.

(4) Very fine dislocation wall structure is formed in UFG Al during fatigue tests at 77 K and the fraction of the grains that contain the dislocation wall structure is about 40%. The dislocation wall structure in UFG Al is found to disappear easily during the early stages of monotonic tensile deformation.

(5) Good correlation is found between the reciprocal of the channel width and the saturation stress amplitude, from single-crystalline Al to UFG Al.

(6) Relatively unstable dislocation wall structure in UFG Al acts as a weak barrier for dislocation motion in monotonic tensile tests and may not be harmful in reducing the fatigue resistance.

Acknowledgments

This study was supported by a Grant-in-Aid for Scientific Research on Innovative Area, “Bulk Nanostructured Metals” through MEXT, Japan (contract No. 22102006).

REFERENCES